



PRODUCT SPECIFICATIONS

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TYPE: MTM3N35

CASE OUTLINE: TO-204AA (TO-3)

HIGH VOLTAGE POWER MOSFET N-CHANNEL

ABSOLUTE MAXIMUM RATING:

| | | | |
|-----------------------------------|-------------------|-------------|-------------|
| Drain – Source Voltage | V_{DSS} | 350 | Vdc |
| Drain – Gate Voltage | V_{DGR} | 350 | Vdc |
| Drain Current – Continuous | I_D | 3.0 | Adc |
| Drain Current – Pulsed | I_{DM} | 8.0 | Adc |
| Gate – Source Voltage | V_{GS} | ± 20 | Vdc |
| Power Dissipation | P_D | 75 | Watts |
| Inductive Current | I_L | | Adc |
| Operating and Storage Temperature | T_J & T_{stg} | -65 to +150 | $^{\circ}C$ |
| Lead Temperature From Case | T_L | 275 | $^{\circ}C$ |

ELECTRICAL CHARACTERISTICS TA @ 25°C

| Parameters | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---------------------------------|--------------|--|------------|-----|-------------|------------|
| Drain Source Breakdown Voltage | BV_{DSS} | $I_D = 5.0mA$ | 350 | | | Vdc |
| Gate Threshold Voltage | $V_{GS(th)}$ | $I_D = 1.0mA$ $I_D = 1.0mA, T_J = 100^{\circ}C$ | 2.0 1.5 | | 4.5 4.0 | Vdc |
| Gate – Body Leakage Current | I_{GSS} | $V_{GS} = 20V$ | | | 500 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 350V$ $V_{DS} = 300V$ | | | 0.25 2.5 | mA |
| On State Drain Current | $I_{D(on)}$ | | | | | Adc |
| Drain Source On Resistance | $r_{DS(on)}$ | $V_{GS} = 10V, I_D = 1.5A,$ | | | 3.3 | Ohms |
| Forward Transconductance | g_{FS} | $V_{DS} = 15V, I_D = 1.5A,$ | 0.75 | | | mhos |
| Drain-Source On-Voltage | $V_{DS(on)}$ | $I_D = 1.5A$ $I_D = 1.5A, T_J = 100^{\circ}C$ | | | 5.0 10 | Vdc Vdc |
| Drain Source On-Voltage | $V_{DS(on)}$ | $I_D = 3.0A$ | | | 12 | Vdc |
| Input Capacitance | C_{iss} | | | | 500 | pF |
| Output Capacitance | C_{oss} | $V_{DS} = 25V, f = 1 MHz$ | | | 100 | pF |
| Reverse Transfer Capacitance | C_{rss} | | | | 50 | pF |



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| Drain Source Diode Characteristics | | Symbol | Min | Typ | Max | Units |
|------------------------------------|--------------|----------|-----|-----|-----|-------|
| Forward On Voltage | $I_S = 3.0A$ | V_{SD} | | 1.0 | | Vdc |
| Reverse Recovery Time | | t_{rr} | | 300 | | ns |
| Forward Turn-On Time | | t_{on} | | | | ns |
| Total Gate Charge | | Q_g | | | | nC |
| Gate – Source Charge | | Q_{gs} | | | | nC |
| Gate – Drain Charge | | Q_{gd} | | | | nC |

| Switching Characteristics | | Symbol | Min | Typ | Max | Units |
|---------------------------|--|--------------|-----|-----|-----|-------|
| Turn-On Time | | t_{on} | | | | |
| Turn-Off Time | | t_{off} | | | | |
| Delay Time (Turn On) | $V_{DS} = 125V, I_D = 1.5A,$ $R_{gen} = 50\Omega$ | $t_{d(on)}$ | | | 40 | ns |
| Rise Time | | t_r | | | 60 | ns |
| Delay Time (Turn Off) | | $t_{d(off)}$ | | | 60 | ns |
| Fall Time | | t_f | | | 30 | ns |

| Thermal Characteristics | | Symbol | | Units |
|----------------------------|--|-----------------|------|---------------|
| Junction To Case | | $R_{\theta JC}$ | 1.67 | $^{\circ}C/W$ |
| Junction To Ambient | | $R_{\theta JA}$ | | $^{\circ}C/W$ |
| Internal Drain Inductance | | L_d | | nH |
| Internal Source Inductance | | L_s | | nH |